SNAP High-Density Digital I/O Modules

Features

- ≥ 16 or 32 digital input points or output points in one compact SNAP module
- Up to 16 high-density digital modules on a SNAP rack, making up to 512 digital points available on one rack
- Convenient pluggable wiring harness, breakout boards, and header cables (available separately)
- 1500 V of isolation protects sensitive control electronics from industrial field signals
- Rugged packaging



SNAP-IDC-32 high-density digital input module

Description

SNAP high-density digital (HDD) modules from Opto 22 provide 16 or 32 digital input or output points in one compact SNAP module. All HDD modules work with the SNAP PAC System, which consists of SNAP PAC controllers and brains, SNAP PAC racks, SNAP I/O modules, and PAC Project software. These modules can also be used in intelligent remote I/O for Allen-Bradley Logix PLC systems.

SNAP high-density digital modules are ideal for OEMs and for anyone who has high point-count applications. The high-density point configuration reduces per-point costs of digital I/O systems by providing up to eight times as many I/O points in the same space.

The following high-density digital modules are available:

- The **SNAP-IDC-32** or **SNAP-IDC-32-FM** digital input module, with 32 input points, can be used to sense on/ off status for 10–32 VDC inputs from sources such as proximity switches, limit switches, push buttons, and pilot switches (PNP or sourcing type).
- The SNAP-IDC-32N is similar, but its input range is -10 to -32 VDC and its common connections are positive rather than negative, making it ideal for NPN or sinking type inputs.
- The **SNAP-IDC-32D** has an input range of 2.5 to 12 VDC.
- The SNAP-IDC-32DN offers a -2.5 to -12 VDC input range and has positive common connections, also suited to NPN (sinking) inputs.
- The SNAP-IDC-16 digital input module offers 16 points with channel-to-channel isolation. It can sense on/off status for 10–32 VDC/VAC loads.
- The SNAP-IDC-HT-16 leakage tolerant digital input module is used with proximity switches. It offers channel-to-channel isolation for 16 points and senses on/off status for loads of 15–28 VDC/VAC.

Part Numbers

Part	Description					
Modules						
SNAP-IDC-32 SNAP-IDC-32-FM*	SNAP 32-point digital input module, 10–32 VDC					
SNAP-IDC-32N	SNAP 32-point digital input mod- ule, -10 to -32 VDC, with positive common connection					
SNAP-IDC-32D	SNAP 32-point digital input module, 2.5 to 12 VDC					
SNAP-IDC-32DN	SNAP 32-point digital input mod- ule, -2.5 to -12 VDC, with positive common connection					
SNAP-IDC-16	SNAP isolated 16-point digital input module, 10–32 VDC/VAC					
SNAP-IDC-HT-16	SNAP leakage-tolerant isolated 16-point digital input module, 15–28 VDC/VAC					
SNAP-IAC-16	SNAP isolated 16-point digital input module, 90–140 VAC/VDC					
SNAP-IAC-A-16	SNAP isolated 16-point digital input module, 180–280 VAC/VDC					
SNAP-IAC-K-16	SNAP isolated 16-point digital input module, 70–130 VAC/VDC					
SNAP-ODC-32-SRC SNAP-ODC-32-SRC-FM*	SNAP 32-point digital output module, 5–60 VDC load sourcing					
SNAP-ODC-32-SNK SNAP-ODC-32-SNK-FM*	SNAP 32-point digital output module, 5–60 VDC load sinking					
Accessories						
OPTOTERMINAL-G20	Terminal with operator controls for use with SNAP high-density digital modules					

^{*} Factory Mutual approved

- SNAP-IAC-16, SNAP-IAC-A-16, and SNAP-IAC-K-16
 digital input modules each have 16 points with channel-to-channel isolation. These modules sense on/off status for 90–140 VAC (SNAP-IAC-16), 180–280 VAC (SNAP-IAC-A-16), or 70–130 VAC (SNAP-IAC-K-16).
- SNAP-ODC-32-SRC, SNAP-ODC-32-SRC-FM, SNAP-ODC-32-SNK, and SNAP-ODC-32-SNK-FM digital output modules have 32 points and can switch on and off 5–60 VDC loads, either sourcing or sinking.

Part numbers ending in -FM are Factory Mutual approved.

All HDD input modules feature automatic counting and latching. DC models are ideal for detecting low-voltage auxiliary contacts.

Mounting Racks

SNAP high-density digital modules are designed to work with SNAP PAC mounting racks. Up to 16 modules can be mounted on a rack, making up to 512 digital points available. In addition, HDD modules can be mixed with 4-channel SNAP digital, analog, and serial modules on the same rack.

SNAP racks have a retention rail locking system. Use two 4-40 by ½-inch standard machine screws to hold each module securely in position on the SNAP rack.

Wiring Aids: Breakout Boards, Wiring Harnesses, and Header Cables

Due to space constraints, instead of using the usual removable terminal connectors, high-density digital modules use other wiring devices. These cables and breakout boards are available separately and are detailed in form 1756, *SNAP TEX Cables and Breakout Boards Data Sheet*, available on our website.

SNAP breakout boards for high-density digital modules provide LED indicators as well as labeled and easily accessible fused connectors for input or output points, all of which simplify connecting field devices to HDD modules.



SNAP-IDC-HDB breakout board

For a table showing compatible boards, cables, and modules, see the SNAP TEX Cables and Breakout Boards Data Sheet.

If you are not using breakout boards, you can connect 16-point input modules directly to field devices or terminal strips using the **SNAP-HD-ACF6** wiring harness assembly. The assembly has two 8-point connectors that plug securely into the top of the module and provide flying leads at the field end.

Similarly, 32-point modules can connect to field devices with the **SNAP-HD-CBF6** wiring harness, which plugs into the top of the module and provides flying leads.

SNAP Product Compatibility

SNAP HDD modules are part of the SNAP PAC System and can be used on SNAP PAC mounting racks with SNAP PAC R-series controllers and SNAP PAC EB and SB brains. These modules can be used with both standard wired Ethernet controllers and brains and with Wired+Wireless[™] models.

Other digital, analog, and serial SNAP I/O modules can be placed on the same rack with HDD modules for the mix of signals required at any location.

NOTE: To use HDD modules in older systems, see form 1688, SNAP PAC System Migration Technical Note.

Programming

Opto 22 PAC Control software version 8.0 or newer is required for SNAP high-density digital modules used with a SNAP PAC controller. SNAP HDD modules can also be accessed by an EtherNet/IP or Modbus/TCP system or by custom software built with the OptoMMP Communication Toolkit.

See form 1547, SNAP High-Density Digital Modules User's Guide, for detailed information on using these modules in a PAC Control strategy. The OptoMMP Communication Toolkit is documented in form 1465, OptoMMP Protocol Guide.

Communication with A-B PLC systems is covered in form 1770, EtherNet/IP for SNAP PAC Protocol Guide. For Modbus/TCP systems, see form 1678, Modbus/TCP Protocol Guide.

OptoTerminal-G20

SNAP high-density digital modules have a diagnostic port for commissioning and troubleshooting using the optional

OptoTerminal-G20 operator interface

operator interface terminal.



The OptoTerminal-G20 displays the status of a high-density digital module's points on a two-line LCD display and can also be used to turn output points on and off. See form 1547, *SNAP*

High-Density Digital Modules User's Guide, for more information

Connecting to G4 Digital I/O

Some 32-channel HDD modules can connect to older G4 and G1 mounting racks, using a special cable, to integrate older G4 digital I/O systems with modern PAC Project software and SNAP Ethernet-based controllers. For outputs, this connection makes available the G4 module's 3-amp switching capability, which provides twelve times the 0.25 amp capability per point of the high-density digital modules themselves.

These HDD modules and cables also work with some G1 racks, and the SNAP-HD-G4F6 works with some integrated I/O racks.

For more information, see form 1756, SNAP TEX Cables and Breakout Boards Data Sheet.

Outputs

Connect SNAP-ODC-32-SNK digital output modules to G4PB16H and G4PB16HC mounting racks using the **SNAP-HD-G4F6** header cable.

- Do not use SNAP-ODC-32-SRC modules with G4 digital.
- All G4 modules on the G4 mounting rack must be outputs and must be the same logic voltage (5, 15, or 24 VDC).



Inputs

SNAP-IDC-32N and SNAP-IDC-32DN digital input modules can connect to G4PB16H and G4PB16HC mounting racks using the **SNAP-HD-G4F6N** header cable.

- All G4 modules on the G4 mounting rack must be inputs and must be the same logic voltage (5, 15, or 24 VDC).
- For 5 volt G4 modules, use the SNAP-IDC-32DN.
- For 15 or 24 volt G4 modules, use the SNAP-IDC-32N.

NOTE: While not designed for this use, it is possible to connect the SNAP-IDC-32 module with G4 15 or 24 V inputs using a SNAP-HD-G4F6 cable. However, the SNAP-IDC-32 uses positive-true logic and therefore returns the inverse of the typical negative-true logic. For example, if the SNAP-IDC-32 is controlled by a PAC Control strategy, an "OFF" state from it actually indicates that the associated G4 module is turned ON.

Comparing SNAP Digital Modules

IMPORTANT: SNAP high-density digital modules differ from each other and from 4-channel SNAP digital modules in several critical areas, including electrical capabilities and I/O performance.

You must consider these differences when deciding which SNAP digital module to use for an application. For example, while a SNAP-IDC-32 digital input module provides 32 I/O points on one module, it does not provide the channel-to-channel isolation of a SNAP-IDC-16 with 16 channels or a SNAP-IDC5 with 4. See the table "Comparing SNAP High-Density and 4-Channel Digital Modules" on page 4 for a comparison of capabilities.

Counting

Digital counting is an important area in which HDD input modules differ from 4-channel SNAP digital input modules. Opto 22 has traditionally provided counting capability for any digital input point when used with a brain that supports high-speed digital features. This counting happens in the brain, not in the module.

SNAP high-density digital modules introduce a different kind of counting, where the counting occurs on the module itself. While the module uses a 16-bit counter (counting only to 65,535), the I/O processor used with the module accumulates counts to 32 bits by periodically getting and clearing the module's counts, and adding each new count to what it already has for that point. However, this is not high-speed counting because it is done on the module, and both the HDD module's speed and communication speed between the brain and the module are limited. Note that counting speed on HDD modules is not deterministic and will vary.

However, this slower counting rate works well for many applications that involve counting at slower speeds—for example, rotating shafts, flow meters with pulsed outputs, and electrical meters tuned to slower speeds.

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Comparing SNAP High-Density and 4-Channel Digital Modules

Item	SNAP High-Density Digital Modules	4-Channel SNAP Digital Modules			
Number of points on module	16 or 32, depending on module	4			
Isolation and fusing	16-point input modules: Each point is optically isolated from other points on the module. 32-point input and output modules: The module is divided into four groups of eight points. Groups are isolated from each other, but points within a group are not isolated from each other. Groups must be externally fused.	Input modules: Each point is optically isolated from other points on the module. Most output modules: Points are not isolated from each other. Points share a common fuse. For isolated modules, see form 1144, SNAP Digital Output Modules Data Sheet.			
Status LEDs	None; use the handheld OptoTerminal-G20 for module diagnostics and commissioning, or for 32-point modules, connect to an optional breakout rack.	One for each point, located on top of module.			
Polling time from I/ O processor to module ¹	2–30 ms typical ²	0.5–2 ms typical ²			
Module turn-on/off time ¹	16-point input modules: 15–20 ms 32-point input modules: 6 ms Output modules: 100 microseconds	Varies by module. Examples: SNAP-IDC5-FAST: 25 microseconds SNAP-IDC5: 5 ms turn-on, 15 ms turn-off			
On/off status	Yes	Yes			
Input latching	Yes	Yes			
Counting on digital input modules	Counting occurs on the module. ³ Counting is available with SNAP-PAC-R1 ⁴ , SNAP-PAC-EB1 ⁴ , and SNAP-PAC-SB1 processors. Counting speeds: On 32-point modules, 0–50 Hz @ 50% duty cycle On 16-point modules, 0–25 Hz @ 50% duty cycle (Speed depends on module; see specifications for each part number.)	High-speed counting occurs on the I/O processor (brain or on-the-rack controller) and can be configured for any point. (High-speed counting is available on SNAP-PAC-R1 ⁴ , SNAP-PAC-EB1 ⁴ , and SNAP-PAC-SB1 processors.) Counting speed varies based on the processor and the speed of the module. Example: SNAP-PAC-EB1 brain with SNAP-IDC5-FAST: up to 20 KHz			
Watchdog timer	Firmware 8.1 and higher, yes. Firmware 8.0 and lower, no.	Yes			
Pulse generation	Yes	Yes			
On-pulse, off-pulse, and Period mea- surement	No	Yes			
Frequency	No	Yes			
Totalizer	No	Yes			
Digital events	Firmware 8.1 and higher, yes. Firmware 8.0 and lower, no.	Yes			

¹ Actual turn-on and turn-off times equal the polling time plus the module time.

² Polling time varies based on the SNAP I/O processor (brain or on-the-rack controller), processor configuration, and Ethernet host communication activity.

³ The high-density digital module uses a 16-bit counter, but the processor used with the module accumulates counts to 32 bits by periodically getting and clearing the module's counts and adding to current values. Update time varies based on number of modules and Ethernet communication demands.

⁴ Including -FM (Factory Mutual approved) and -W (Wired+Wireless) models, and the SNAP-PAC-R1-B.

Specifications

SNAP-IDC-32 SNAP-IDC-32-FM		SNAP-IDC-32N	SNAP-IDC-32D	SNAP-IDC-32DN	
Input Range	10 to 32 VDC	-10 to -32 VDC	2.5 to 12 VDC	-2.5 to -12 VDC	
Nominal Voltage Range	24 VDC	-12 to -24 VDC	2.5 VDC	-2.5 VDC	
Input Resistance	20 K ohms	20 K ohms	3 K ohms	3 K ohms	
Logic Voltage and Current	5 VDC ± 0.1 @ 150 mA		5 VDC ± 0.1 @ 150 mA		
Maximum Operating Common Mode Voltage	250 V	250 V	250 V	250 V	
Isolation: Field to Logic	1500 V	1500 V	1500 V	1500 V	
Input Arrangement	32 input channels; 4 gro	ups of 8 inputs each	32 input channels; 4 gro	ups of 8 inputs each	
Common connection	Points in each group share a common negative connection.	Points in each group share a common positive connection.	Points in each group share a common negative connection.	Points in each group share a common positive connection.	
Channel-to-Channel Isolation	No channel-to-channel is 100 V group-to-group iso	,	No channel-to-channel isolation; 100 V group-to-group isolation		
Hold-down screws Connector screws	Torque: 4 in-lb (0.45 N-n Torque: 5.26 in-lb (0.6 N		Torque: 4 in-lb (0.45 N-m) Torque: 5.26 in-lb (0.6 N-m)		
Maximum Number of HDD Modules on One Mounting Rack	16	16	16	16	
Indicators	None; use optional Opto	Terminal-G20 diagnostic	display or breakout rack.	1	
ON Voltage	10 VDC @ 0.5 mA	-10 VDC @ 0.5 mA	2.5 VDC @ 0.5 mA	-2.5 VDC @ 0.5 mA	
OFF Voltage	3 VDC @ 0.1 mA	-3 VDC @ 0.1 mA	1 VDC @ 0.1 mA	-1 VDC @ 0.1 mA	
Polling time from I/O processor to module ¹	2–30 ms typical ²	2–30 ms typical ²	2–30 ms typical ²	2–30 ms typical ²	
Input Turn-On/Off Time	6 ms	6 ms 6 ms		6 ms	
Counting Frequency (DC input)	0-50 Hz @ 50% duty cycle	0-50 Hz @ 50% duty cycle	0-50 Hz @ 50% duty cycle	0-50 Hz @ 50% duty cycle	
Operating Temperature	-20 to 70 °C	-20 to 70 °C	-20 to 70 °C	-20 to 70 °C	
Storage Temperature	-40 to 85 °C	-40 to 85 °C	-40 to 85 °C	-40 to 85 °C	
Agency Approvals	UL, CE, RoHS, DFARS FM (-FM model only)	CE, RoHS, DFARS	CE, RoHS, DFARS	CE, RoHS, DFARS	
Warranty	Lifetime	Lifetime	Lifetime	Lifetime	

¹ Affects turn-on and turn-off determination

² Time varies based on the SNAP PAC I/O processor (brain or on-the-rack controller), processor configuration, and Ethernet host communication activity.

Specifications (continued)

	SNAP-IDC-16 SNAP-IDC-HT-16		SNAP-IAC-16	SNAP-IAC-A-16	SNAP-IAC-K-16		
Input Range	10-32 VDC/VAC	15-28 VDC/VAC	90-140 VAC/VDC	180-280 VAC/VDC	70-130 VAC/VDC		
Nominal Voltage Range	24 VDC	24 VDC	120 VAC	240 VAC	100 VAC		
Input Resistance	44 K ohms	4 K ohms	300 K ohms	940 K ohms	220 K ohms		
Logic Voltage and Current	5 VDC ± 0.1 @ 150 mA	5 VDC ± 0.1 @ 150 mA	5 VDC ± 0.1 @ 150 mA	5 VDC ± 0.1 @ 150 mA	5 VDC ± 0.1 @ 150 mA		
Input Arrangement	16 isolated in	put channels	16	isolated input channe	els		
Channel-to-Channel Isolation	250 V ste 1500 V t	ady-state, transient	250 V steady-state, 1500 V transient				
Maximum Operating Common Mode Voltage	250 V	250 V	250 V	250 V	250 V		
Isolation: Field to Logic	1500 V	1500 V	1500 V	1500 V	1500 V		
Maximum Number of HDD Modules on One Mounting Rack	16	16	16	16	16		
Indicators	None; use optional of diagnostic display.	OptoTerminal-G20	None; use optional OptoTerminal-G20 diagnostic display.				
ON Voltage	10 VDC @ 0.230 mA	15 VDC @ 3.50 mA	90 VAC/VDC @ 0.3 mA	180 VAC/VDC @ 0.191 mA	70 VAC/VDC @ 0.3 mA		
OFF Voltage	3 VDC @ 0.05 mA	9 VDC @ 2.0 mA	40 VAC/VDC @ 0.135 mA	40 VAC/VDC @ 0.043 mA	30 VAC/VDC @ 0.135 mA		
Torque, hold-down screws	4 in-lb (0.45 N-m)	4 in-lb (0.45 N-m)	4 in-lb (0.45 N-m)	4 in-lb (0.45 N-m)	4 in-lb (0.45 N-m)		
Torque, connector screws	5.26 in-lb (0.6 N-m)	5.26 in-lb (0.6 N-m)	5.26 in-lb (0.6 N-m) 5.26 in-lb (0.6 N-m)		5.26 in-lb (0.6 N-m)		
Polling time from I/O processor to module ¹	2–30 ms typical ²	2–30 ms typical ²	2–30 ms typical ² 2–30 ms typical ²		2–30 ms typical ²		
Input Turn-On/Off Time	15 ms turn-on time 20 ms turn-off time	20 ms turn-on time 25 ms turn-off time	15 ms turn-on time 20 ms turn-off time	15 ms turn-on time 20 ms turn-off time	15 ms turn-on time 20 ms turn-off time		
Counting Frequency (DC input)	0-25 Hz @ 50% duty cycle	0-15 Hz @ 50% duty cycle	0-25 Hz @ 50% duty cycle	0-25 Hz @ 50% duty cycle	0-25 Hz @ 50% duty cycle		
Operating Temperature	-20 to 70 °C	-20 to 70 °C	-20 to 70 °C	-20 to 70 °C	-20 to 70 °C		
Storage Temperature	-40 to 85 °C	-40 to 85 °C	-40 to 85 °C -40 to 85 °C		-40 to 85 °C		
Agency Approvals	UL, CE, RoHS, DFARS	CE, RoHS, DFARS	UL, CE, RoHS, DFARS UL, CE, RoHS		CE, RoHS, DFARS		
Warranty	Lifetime	Lifetime	Lifetime	Lifetime	Lifetime		

¹ Affects turn-on and turn-off determination

² Time varies based on the SNAP PAC I/O processor (brain or on-the-rack controller), processor configuration, and Ethernet host communication activity.

Specifications (continued)

	SNAP-ODC-32-SRC SNAP-ODC-32-SRC-FM	SNAP-ODC-32-SNK SNAP-ODC-32-SNK-FM			
Switching Voltage	5–60 VDC	5–60 VDC			
Nominal Switching Voltage	12–24 VDC	12–24 VDC			
Logic Voltage and Current	5 VDC ± 0.1 @ 150 mA	5 VDC ± 0.1 @ 150 mA			
Maximum Off State Voltage	60 VDC	60 VDC			
Output Leakage, Typical	<10 microamps per channel (60 V, 70 °C)	<10 microamps per channel (60 V, 70 °C)			
Maximum Load per Point	0.25 A	0.25 A			
Voltage Drop	0.15 VDC @ 0.25 A	0.15 VDC @ 0.25 A			
Surge (1 sec.)	1 A	1 A			
Output Arrangement	32 output channels; 4 groups of 8 outputs each. Points in each group share a common positive connection.	32 output channels; 4 groups of 8 outputs each. Points in each group share a common negative connection.			
Maximum Operating Common Mode Voltage	250 V	250 V			
Isolation: Field to Logic	1500 V	1500 V			
Output Turn-On/Off Time	100 microseconds	100 microseconds			
Polling time from I/O processor to module ¹	2–30 ms typical ²	2–30 ms typical ²			
Indicators	None; use optional OptoTerminal-G20 diagnostic display or breakout rack.	None; use optional OptoTerminal-G20 diagnostic display or breakout rack.			
Maximum Number of HDD Modules on One Mounting Rack	16	16			
Torque, hold-down screws	4 in-lb (0.45 N-m)	4 in-lb (0.45 N-m)			
Torque, connector screws	5.26 in-lb (0.6 N-m)	5.26 in-lb (0.6 N-m)			
Operating Temperature	-20 to 70 °C	-20 to 70 °C			
Storage Temperature	-40 to 85 °C	-40 to 85 °C			
Agency Approvals	SNAP-ODC-32-SRC: UL, CE, RoHS, DFARS SNAP-ODC-32-SRC-FM: CE, FM, RoHS, DFARS	SNAP-ODC-32-SNK: UL, CE, RoHS, DFARS SNAP-ODC-32-SNK-FM: CE, FM, RoHS, DFARS			
Warranty	Lifetime	Lifetime			

¹ Affects turn-on and turn-off determination

² Time varies based on the SNAP PAC I/O processor (brain or on-the-rack controller), processor configuration, and Ethernet host communication activity.

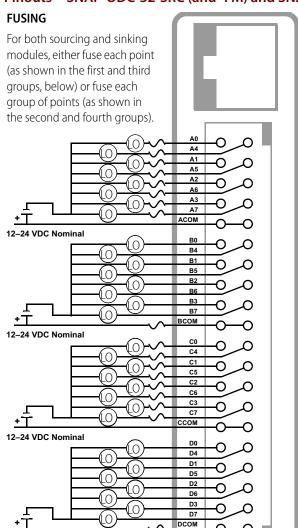
12-24 VDC Nominal

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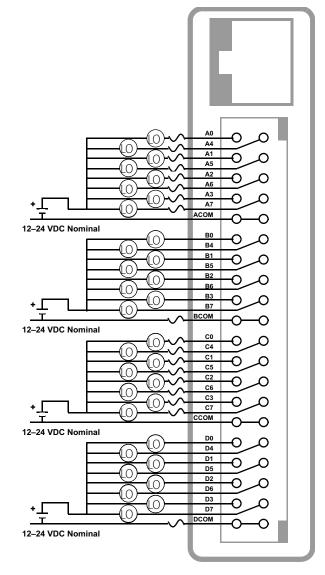
SNAP High-Density Digital I/O Modules

Pinouts and Wiring

Pinouts—SNAP-ODC-32-SRC (and -FM) and SNAP-ODC-32-SNK (and -FM) Digital Modules



SNAP-ODC-32-SRC Load Sourcing Module (Top view of module)

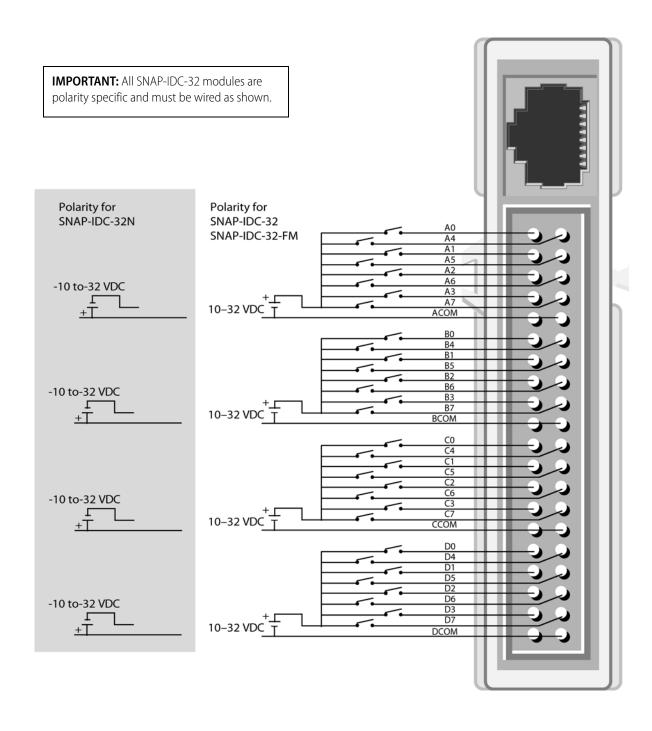


SNAP-ODC-32-SNK Load Sinking Module (Top view of module)

NOTE: The SNAP-ODC-32-SRC and SNAP-ODC-32-SNK modules (includes -FM models) have built-in transient suppression for each channel. Additional commutating diodes are not necessary.

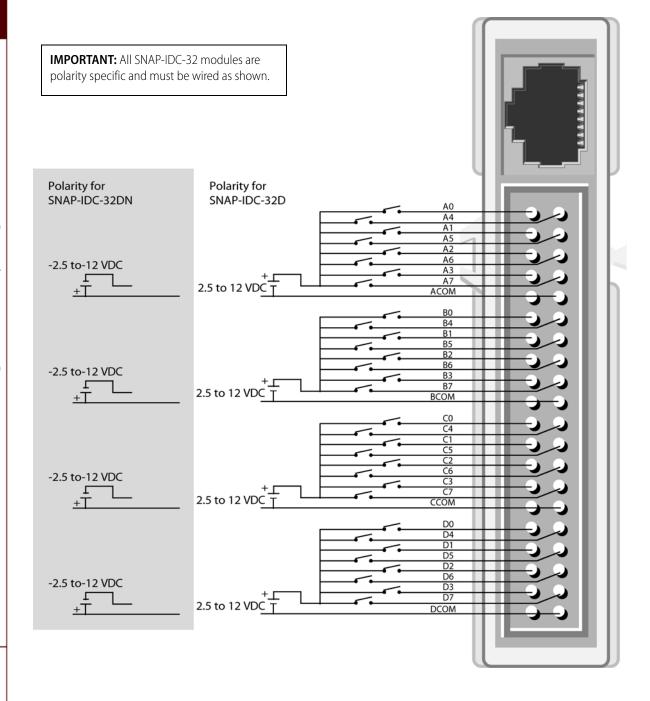
Pinouts and Wiring (continued)

Pinouts for SNAP-IDC-32, SNAP-IDC-32-FM, and SNAP-IDC-32N Digital Modules



Pinouts and Wiring (continued)

Pinouts for SNAP-IDC-32D and SNAP-IDC-32DN Digital Modules



SNAP High-Density Digital I/O Modules

Pinouts and Wiring (continued)

Connector Wiring—SNAP 32-Point Digital Modules

The following diagram shows 32-channel module connector wiring for the SNAP-HD-CBF6 wiring harness.

Wires from the wiring harness are grouped into four sets. Each set contains color-coded wires.

				C					
Harness	Pin		- 1					Pin	Harness
Wire Color	Number	Signal	- 1	7			Signal	Number	Wire Color
Gray	40	A0	-			-	_A4	39	White
Blue	38	A1	4	\rightarrow	0—	-	_A5	37	Violet
Yellow	36	A2	4	→	○	-	A6	35	Green
Red	34	A3	4	—	○	-	A7	33	Orange
Black	32	ACOM	4	\rightarrow	0	-	ACOM	31	Brown
Gray	30	В0	4	<u> </u>	0	-	B4	29	White
Blue	28	B1	4	_	0	-	B5	27	Violet
Yellow	26	B2	4	<u>_</u>	0	-	_B6	25	Green
Red	24	В3	4	<u>_</u>	0	-	_B7	23	Orange
Black	22	BCOM	4	<u>_</u>	0	-	BCOM	21	Brown
Gray	20	C0	4	 -	0	-	C4	19	White
Blue	18	C1	4	→ ₀	0	-	C5	17	Violet
Yellow	16	C2	4	→ ₀	0	-	_C6	15	Green
Red	14	C3	4	→ ₀	0	-	_C7	13	Orange
Black	12	CCOM	4	→ ₀	0—	-	CCOM	11	Brown
Gray	10	D0	4		0	-	D4	9	White
Blue	8	D1	4	<u>_</u>	<u> </u>	4	_ D5	7	Violet
Yellow	6	D2	4	<u></u>	<u> </u>	4	D6	5	Green
Red	4	D3	4	<u></u>	<u> </u>	4	D7	3	Orange
Black	2	DCOM	4	<u>_</u>	0	_	DCOM	1	Brown

Connector wiring for SNAP-ODC-32-SNK, SNAP-ODC-32-SRC, SNAP-IDC-32, -FM versions, SNAP-IDC-32N, and SNAP-IDC-32DN (top view of module)

Building Your Own Wiring Harness or Header Cable for a 32-channel module

To build your own wiring harness similar to the SNAP-HD-CBF6, you will need the following parts:

Connector: Molex 15-04-5401 **Pin housing:** Molex 50-57-9320 **Pins:** Molex p/n 16-02-0103

Cable: Alpha 5020/40c (24 AWG, 40 conductor) or equivalent

(UL type CM)

To build your own SNAP-HD-BF6 header cable for use with either breakout rack, you will need the parts listed below. Both ends of the cable use the same connectors.

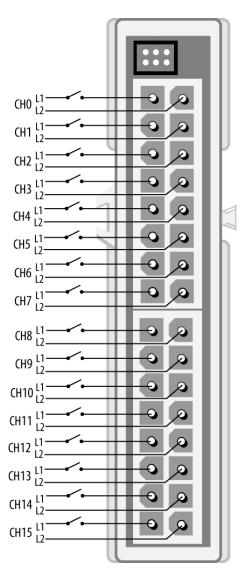
Connector: Molex 15-04-5401 **Pin housing:** Molex 50-57-9320 **Pins:** Molex p/n 16-02-0103

Cable: Alpha 5020C or Manhattan M38910 (24 AWG, 10 conductor, 4x length needed) or equivalent (UL type CM)

Pinouts and Wiring (continued)

Pinouts—16-Channel Digital Input Modules

Applies to the SNAP-IDC-16, SNAP-IDC-HT-16, SNAP-IAC-16, SNAP-IAC-A-16, and SNAP-IAC-K-16.



NOTE: The connectors on these modules are not polarity-sensitive. You can connect the positive lead (+) for each channel (or point) to either L1 or L2, and this can vary from point to point on the module.

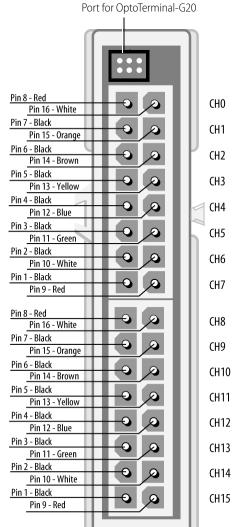
SNAP High-Density Digital I/O Modules

Pinouts and Wiring (continued)

Connector Wiring—SNAP 16-Point Digital Modules

The following diagram shows 16-channel module connector wiring for the SNAP-HD-ACF6 wiring harness. Applies to SNAP-IDC-16, SNAP-IDC-HT-16, SNAP-IAC-16, SNAP-IAC-A-16, and SNAP-IAC-K-16 high-density digital modules.

NOTE: The small four-pin connector on the top of a 16-point module connects to the optional OptoTerminal-G20 using a special adapter cable, included with the OptoTerminal.



Top View of Module

Building Your Own Wiring Harness for a 16-channel Module

To build your own wiring harness similar to the SNAP-HD-ACF6, you will need the following parts:

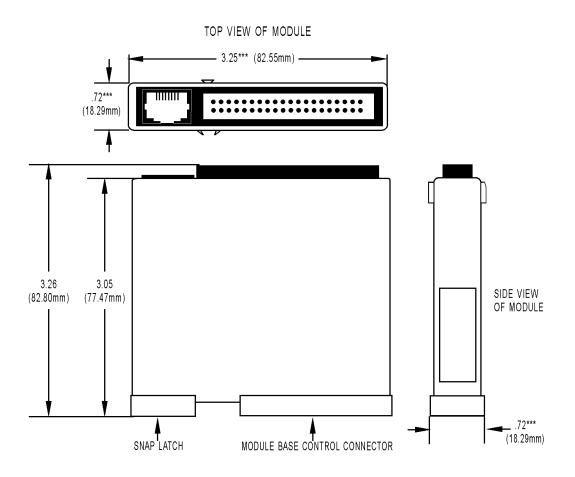
Connector: Molex 39-01-2165 Pins: Molex 39-00-0214

Cable: Belden 8308 (22 AWG, 16 conductor, shielded) or

equivalent (UL AWM style 2464)

Dimensional Drawings

SNAP 32-Point Digital Modules

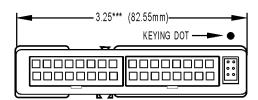


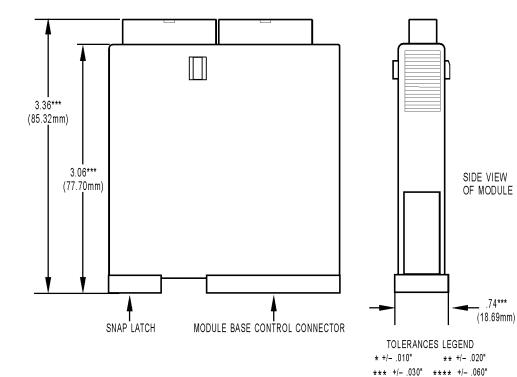
TOLERANCES LEGEND * +/- .010" ** +/- .020" *** +/- .030" **** +/- .060" NO * REFERENCE ONLY

Dimensional Drawings (continued)

SNAP 16-Point Digital Modules

TOP VIEW OF MODULE





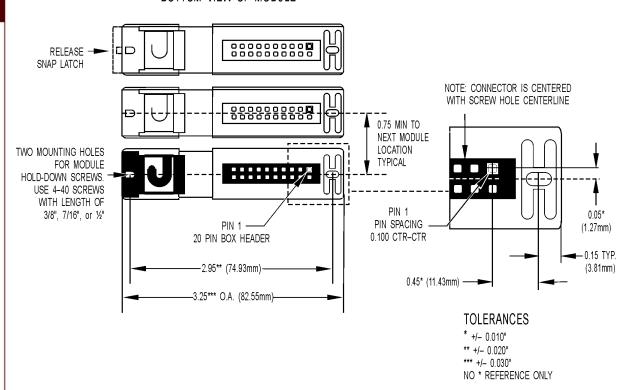
NO * REFERENCE ONLY

SNAP High-Density Digital I/O Modules

Dimensional Drawings (continued)

SNAP High-Density Digital Modules (All)

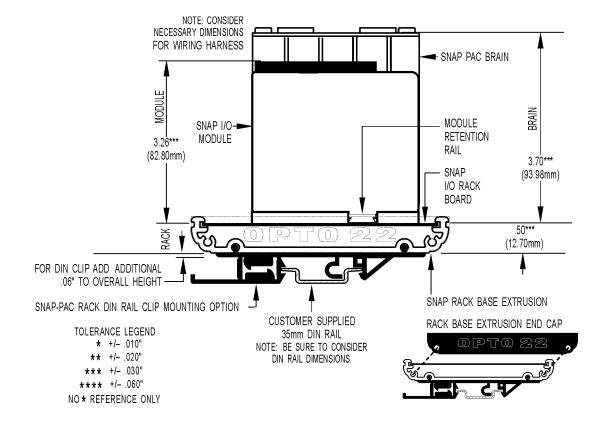
BOTTOM VIEW OF MODULE



IMPORTANT: The mounting rack connector has 24 pins; the module connector has 20 pins. The extra pins on the mounting rack connector prevent misalignment of the module during installation.

Dimensional Drawings (continued)

SNAP High-Density Digital Modules (All)



More About Opto 22

Products

Opto 22 develops and manufactures reliable, easy-to-use, open standards-based hardware and software products deployed worldwide.

Industrial automation, process control, building automation, industrial refrigeration, remote monitoring, data acquisition, Industrial Internet of Things (IIoT), and information technology applications all rely on Opto 22.



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Monitor and control your equipment from anywhere using your smartphone or tablet with groov. Build your own mobile app easily—just drag, drop, and tag. No programming or coding. Visit groov.com for more information and your free trial.

RESTful AF

SNAP PAC System

Developer- and IIoT-ready, the SNAP PAC System connects physical assets to databases and applications using open standards. The SNAP PAC System consists of four integrated components:

- SNAP PAC controllers
- PAC Project Software Suite
- SNAP PAC brains
- SNAP I/O[™]

SNAP PAC Controllers

SNAP PAC programmable automation controllers handle a wide range of digital, analog, and serial functions for data collection, remote monitoring, process control, and discrete and hybrid manufacturing.

For IIoT applications and easier integration with company systems, standalone and rack-mounted SNAP PACs include a built-in HTTP/HTTPS server and **RESTful API** (application program interface). The REST API gives you secure, direct access to I/O and variable data using your choice of programming languages. No middleware, protocol converters, drivers, or gateways needed.

Based on open Ethernet and Internet Protocol (IP) standards, SNAP PACs make it easier to build or extend a system without the expense and limitations of proprietary networks and protocols.

PAC Project Software Suite

Opto 22's PAC Project Software Suite offers full-featured, cost-effective control programming, HMI (human machine interface), OPC server, and database connectivity software.

Control programming includes both easy-to-learn flowcharts and optional scripting. Commands are in plain English; variables and I/O point names are fully descriptive.

PAC Project Basic offers control and HMI tools and is free for download on our website, www.opto22.com. PAC Project Professional, available for separate purchase, adds one SoftPAC software-based controller, OptoOPCServer, OptoDataLink, options for controller redundancy or segmented networking, and support for legacy Opto 22 serial *mistic*™ I/O units.

SNAP PAC Brains

While SNAP PAC controllers provide central control and data distribution, SNAP PAC brains provide distributed intelligence for I/O processing and communications. Brains offer analog, digital, and serial functions, including thermocouple linearization, local PID loop control, watchdog, totalizing, and much more.

SNAP I/O

I/O provides the local connection to sensors and equipment. Opto 22 SNAP I/O offers 1 to 32 points of reliable I/O per module. Analog, digital, and serial modules are mixed on one mounting rack and controlled by a SNAP PAC brain or rack-mounted PAC.

Quality

Founded in 1974, Opto 22 has established a worldwide reputation for high-quality products. All are made in the U.S.A. at our manufacturing facility in Temecula, California.

Because we test each product twice before it leaves our factory, rather than only testing a sample of each batch, we can guarantee most solid-state relays and optically isolated I/O modules for life.

Free Product Support

Opto 22's California-based Product Support Group offers free, comprehensive technical support for

Opto 22 products from engineers with decades of training and experience. Support is available in English and Spanish by phone or email, Monday–Friday, 7 a.m. to 5 p.m. PST.

Additional support is always available on our website: how-to videos, OptoKnowledgeBase, self-training guide, troubleshooting and user's guides, and OptoForums.

In addition, hands-on training is available for free at our Temecula, California headquarters, and you can register online.

Purchasing Opto 22 Products

Opto 22 products are sold directly and through a worldwide network of distributors, partners, and system integrators. For more information, contact Opto 22 headquarters at 800-321-6786 (toll-free in the U.S. and Canada) or 951-695-3000, or visit our website at www.opto22.com.

